

# FLIP - STATION

FLIP-STATION

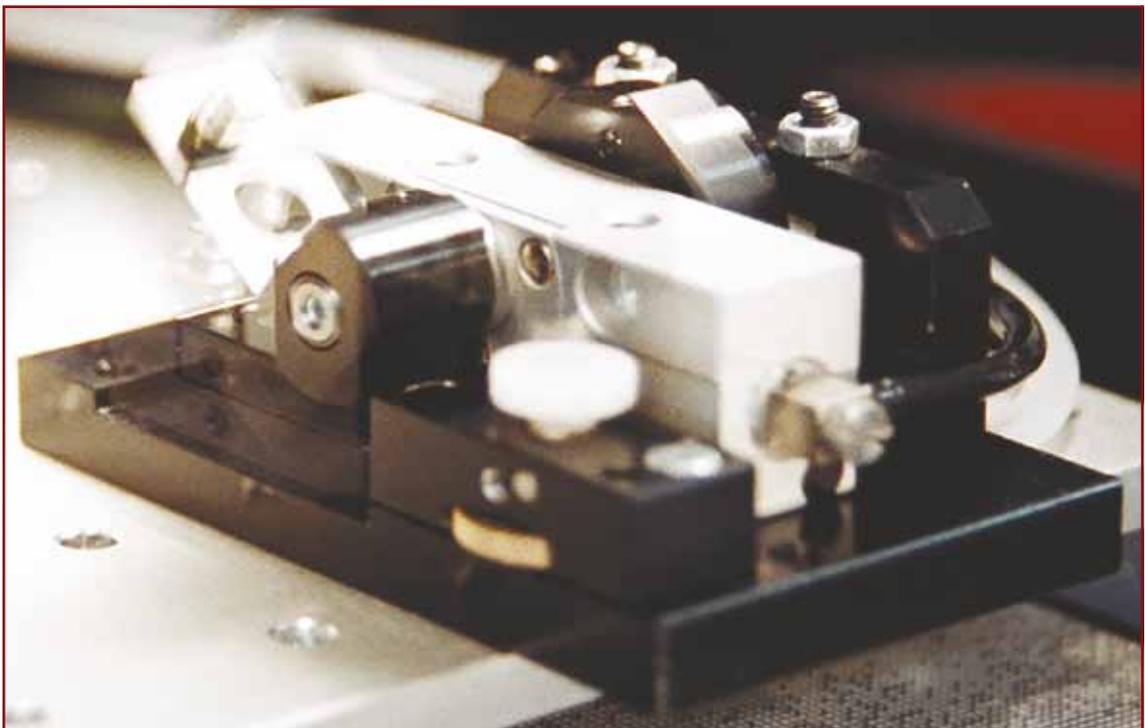
MICRO ASSEMBLY

OPTION

The Tresky **DIE FLIP - STATION** is designed to minimize the mechanical stress on the Chip to avoid any damage. The soft flipping of the DIE upside down is gentle controlled and can be activated manual or automatic. An exchangeable tip and support plate allows to handle a wide range of DIE sizes. The adjustable speed and height gives you the most possible flexibility to flip a DIE.

Flips any devices

Easy tool change



# TRESKY